

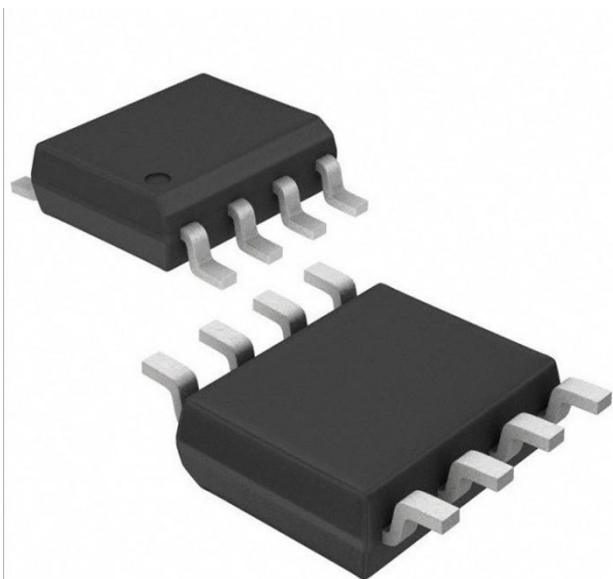
## Description

The US5S105 is a low skew, single input to five output, clock buffer. Part of Ultrasilicon' Clock family, this is a low skew, small clock buffer.

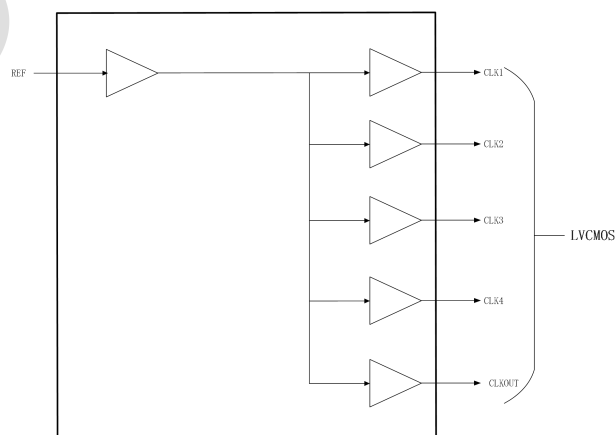
Operates in a 1.8-V, 2.5-V and 3.3-V environment and are characterized for operation from -40°C to 85°C.

## Features

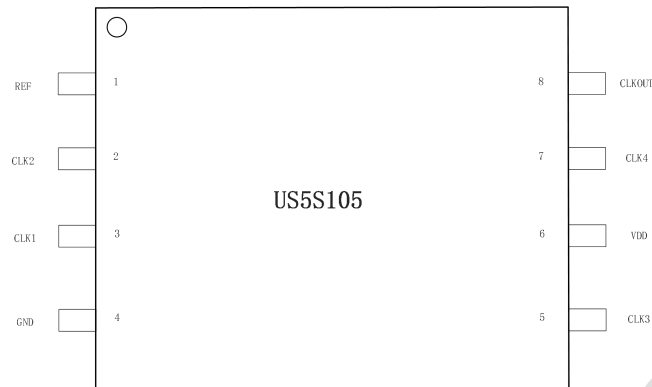
- High-Performance 1:5 LVCMOS Clock Buffer
- Extremely low additive jitter < 25-fs nominal
- Output Skew < 50 ps (Typical)
- Very low propagation delay < 3 ns
- Outputs Operate up to 250 MHz for 3.3V
- Outputs Operate up to 200 MHz for 2.5V and 1.8V
- Supply voltage: 3.3V, 2.5V or 1.8V
- Industrial Temperature Range: -40°C to 85°C
- Available in 8-Pin SOP Package



## Block Diagram



## Pin Assignment



## Pin Descriptions and Function Table

Pin Number	Pin Name	Pin Type	Pin Description
1	REF	Input	Single-ended clock input with internal 150-k $\Omega$ (typical) pulldown resistor to GND. Typically connected to a single-ended clock input.
2	CLK2	Output	LVC MOS Output 2, Typically connected to a receiver. Unused outputs can be left floating.
3	CLK1	Output	LVC MOS Output 1, Typically connected to a receiver. Unused outputs can be left floating.
4	GND	Power	Ground
5	CLK3	Output	LVC MOS Output 3, Typically connected to a receiver. Unused outputs can be left floating.
6	VDD	Power	Connect to +1.8V, +2.5V, +3.3V .
7	CLK4	Output	LVC MOS Output 4, Typically connected to a receiver. Unused outputs can be left floating.
8	CLKOUT	Output	LVC MOS CLKOUT. Typically connected to a receiver. Unused outputs can be left floating.

## Absolute Maximum Ratings

Exposure to absolute maximum rating conditions for extended periods may affect product reliability. Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of the product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied.

Item	Rating
V <sub>DD</sub> : Supply voltage	4.6V
REF : Input voltage	-0.3V ~ VDD + 0.3V
T <sub>J</sub> : Junction Temperature	150°C
T <sub>STG</sub> : Storage Temperature	-65°C to 150°C

## ESD Ratings

		Max	Unit
V(ESD) Electrostatic discharge	Human-body model (HBM), ANSI/ESDA/JEDEC JS-001-2017	±2500	V
	Machine model (MM), JEDEC Std. JESD22-A115-C	±250	
	Charged-device model (CDM), ANSI/ESDA/JEDEC JS-002-2018	±750	

## Latch up

		Max	Unit
Latch up	I-test, JEDEC STD JESD78E	±200	mA
	V-test, JEDEC STD JESD78E	4.6	V

## Recommended Operating Conditions

Symbol	Parameter	Min	Typ	Max	Unit
T <sub>A</sub>	Ambient air temperature	-40		85	°C
T <sub>J</sub>	Junction temperature			125	°C
V <sub>DD</sub>	Power supply for Core and input Buffer blocks	3.3-5%	3.3	3.3+5%	V
		2.5-5%	2.5	2.5+5%	
		1.8-5%	1.8	1.8+5%	

## DC Electrical Characteristics

VDD=1.8V ±5% , Ambient temperature -40°C to +85°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		1.71		1.89	V
Input High Voltage, REF	VIH	Nominal switching threshold is VDD/2	0.7*VDD		3.6	V
Input Low Voltage, REF	VIL				0.3*VDD	V
Input High Current, REF	IIH				30	uA
Input Low Current, REF	IIL				1	uA
Output High Voltage	VOH	IOH = -8 mA	1.4			V
Output Low Voltage	VOL	IOL = 8 mA			0.4	V
Operating Supply Current	IDD	No load, 135 MHz		15		mA

VDD=2.5V ±5%, Ambient temperature -40°C to +85°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		2.375		2.625	V
Input High Voltage, REF	VIH	Nominal switching threshold is VDD/2	0.7*VDD		3.6	V
Input Low Voltage, REF	VIL				0.3*VDD	V
Input High Current, REF	IIH				30	uA
Input Low Current, REF	IIL				1	uA
Output High Voltage	VOH	IOH = -8 mA	2			V
Output Low Voltage	VOL	IOL = 8 mA			0.4	V
Operating Supply Current	IDD	No load, 135 MHz		19		mA

VDD=3.3V ±5% , Ambient temperature -40°C to +85°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		3.135	3.3	3.465	V
Input High Voltage, REF	VIH	Nominal switching threshold is VDD/2	0.7*VDD		3.6	V
Input Low Voltage, REF	VIL				0.3*VDD	V
Input High Current, REF, OE	IIH				30	uA
Input Low Current, REF, OE	IIL				1	uA
Output High Voltage	VOH	IOH = -8 mA	2.8			V
Output Low Voltage	VOL	IOL = 8 mA			0.2	V
Operating Supply Current	IDD	No load, 135 MHz		24		mA

## AC Electrical Characteristics

VDD = 1.8V  $\pm$ 5%, Ambient Temperature -40°C to +85°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0.1		200	MHz
Output Rise Time	t <sub>OR</sub>	20% to 80%		1.0	1.5	ns
Output Fall Time	t <sub>OF</sub>	80% to 20%		1.0	1.5	ns
Propagation Delay	Note 1			2.0	4.0	ns
Output to output skew	Note 2	Rising edges at VDD/2			50	ps
Additive jitter	Jitter <sub>ADD</sub>	100MHz, 12KHz to 20MHz		55	85	fs

VDD = 2.5V  $\pm$ 5%, Ambient Temperature -40°C to +85°C, unless stated otherwise

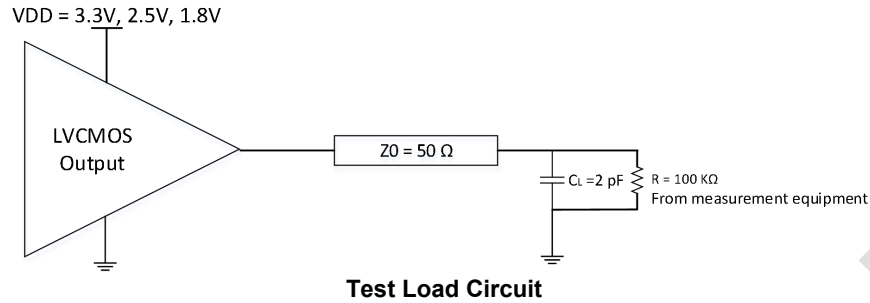
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0.1		200	MHz
Output Rise Time	t <sub>OR</sub>	20% to 80%		1.0	1.5	ns
Output Fall Time	t <sub>OF</sub>	80% to 20%		1.0	1.5	ns
Propagation Delay	Note 1			1.5	3.0	ns
Output to output skew	Note 2	Rising edges at VDD/2		0	50	ps
Additive jitter	Jitter <sub>ADD</sub>	100MHz, 12KHz to 20MHz		25	45	fs

VDD = 3.3V  $\pm$ 5%, Ambient Temperature -40°C to +85°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0.1		250	MHz
Output Rise Time	t <sub>OR</sub>	20% to 80%		1.0	1.5	ns
Output Fall Time	t <sub>OF</sub>	80% to 20%		1.0	1.5	ns
Propagation Delay	Note 1			1.0	2.0	ns
Output to output skew	Note 2	Rising edges at VDD/2		0	50	ps
Additive jitter	Jitter <sub>ADD</sub>	100MHz, 12KHz to 20MHz		20	35	fs

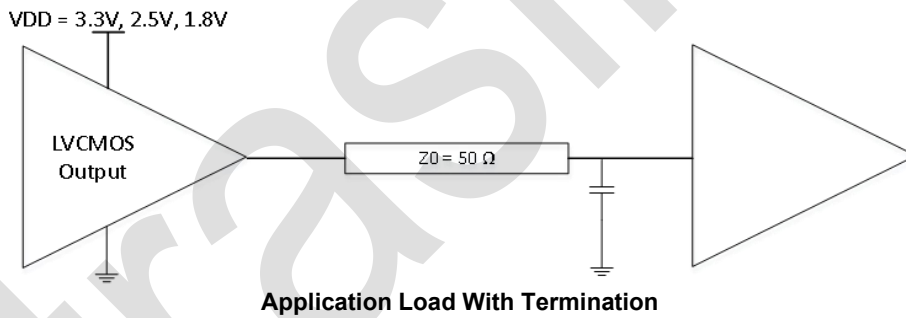
Notes: 1. With rail to rail input clock  
 2. Between any 2 outputs with equal loading.

## Parameter Measurement Information

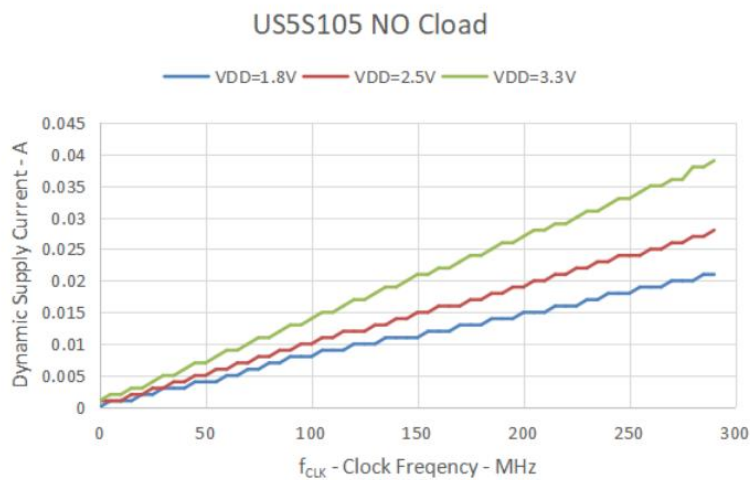


**Note:**

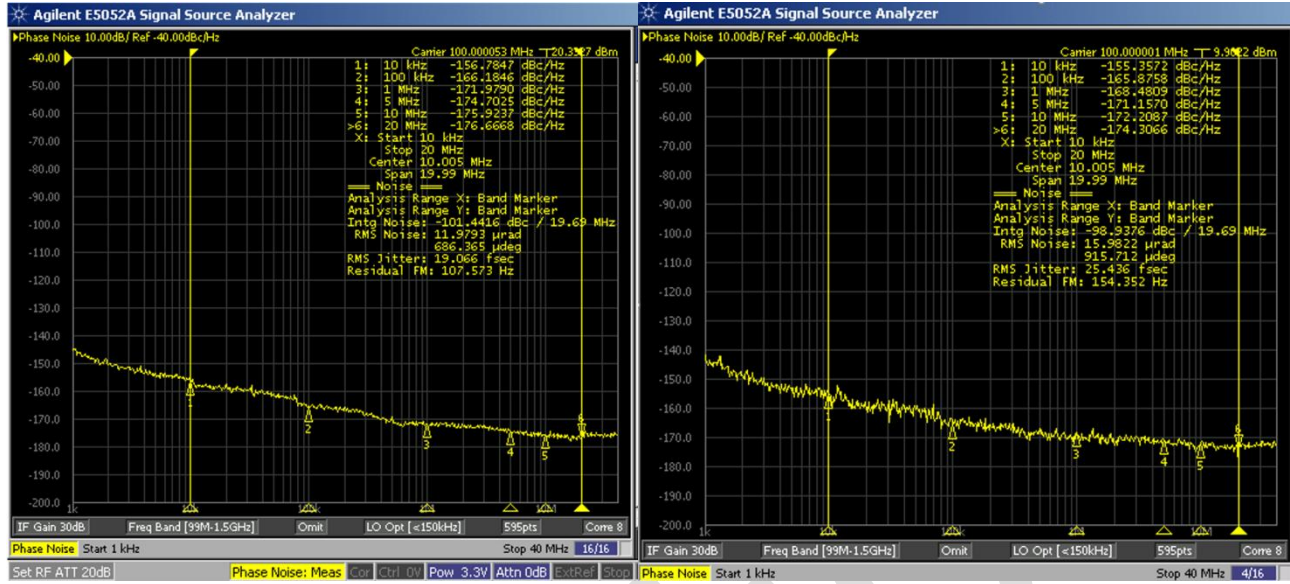
1.  $C_L$  include probe and jig capacitance.
2. All input pulses are supplied by generators having the following characteristics: Clock Frequency  $\leq 250\text{MHz}$ ,  $Z_0 = 50 \Omega$ ,  $t_r < 1.2\text{ns}$ ,  $t_f < 1.2\text{ns}$ .



### Dynamic Supply Current vs. Clock Frequency



## Phase Noise Plot

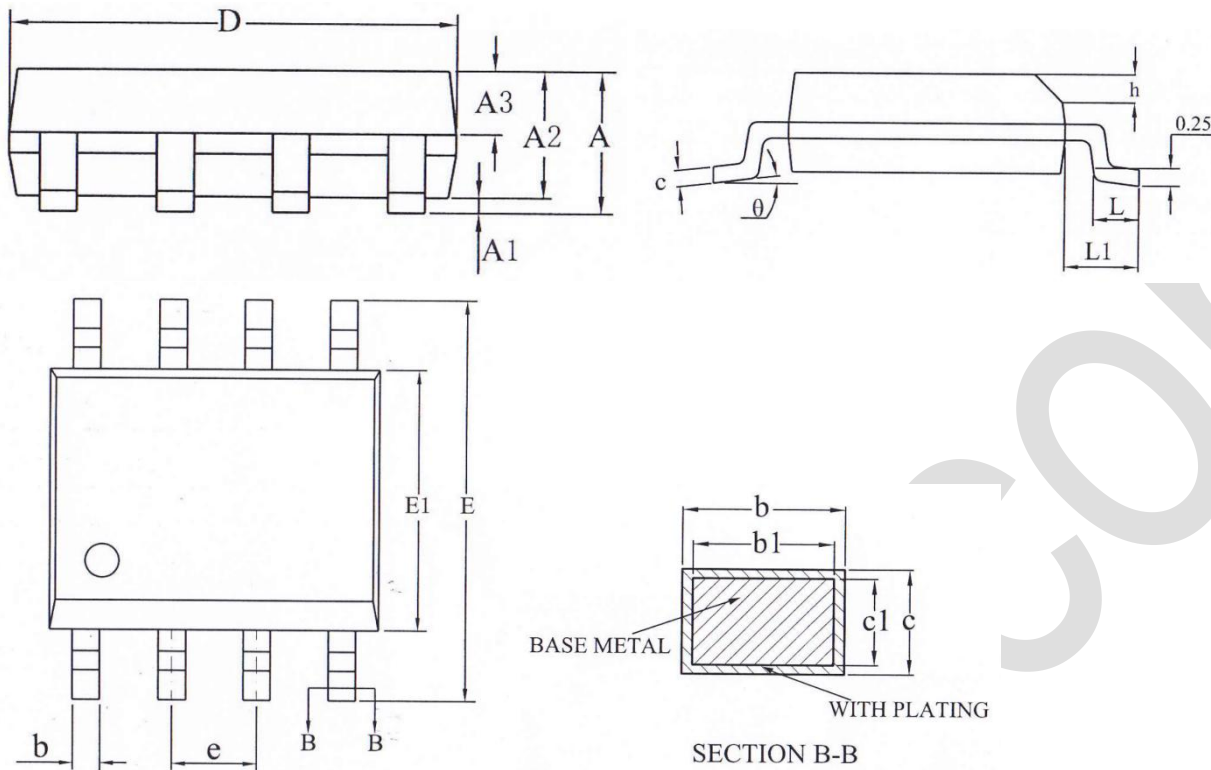


Wenzel 100MHz OCXO(19fs)

Output Phase Noise(25.5fs)

The additive phase jitter for this device was measured using the Wenzel 100MHz OCXO(19fs) as an input source with an Agilent E5052A phase noise analyzer. (VDD=3.3V)

### Package Outline and Package Dimensions (8 pin SOP)

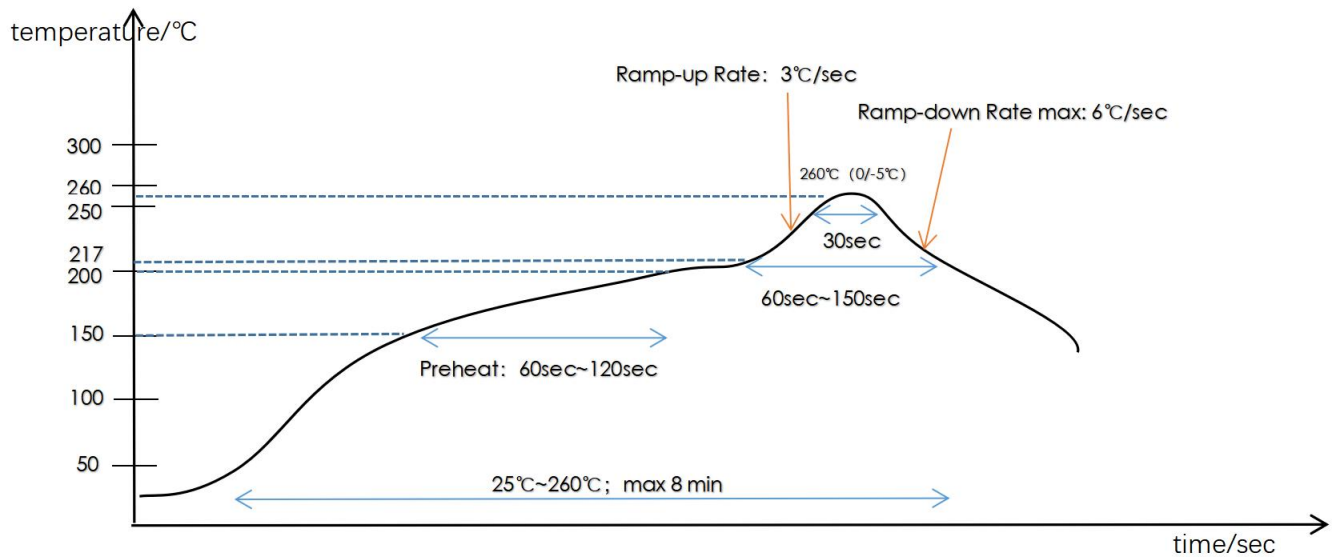


Package dimensions are kept current with JEDEC Publication No. 95

Symbol	Millimeters		
	Min	Nom	Max
A	-	-	1.75
A1	0.10	-	0.225
A2	1.30	1.40	1.50
A3	0.60	0.65	0.70
b	0.39	-	0.47
b1	0.38	0.41	0.44
c	0.20	-	0.24
c1	0.19	0.20	0.21
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27 Basic		
h	0.25	-	0.50
L	0.50	-	0.80
$\theta$	0°	-	8°



## Reflow profile



### Recommended Temperature(PB-Free)

Reflow Condition	Convection or IR/Convection
Average ramp-up rate (217 °C to Peak)	3 °C/second max.
Preheat temperature 175(±25) °C	60-120 seconds
Temperature maintained above 217 °C	60-150 seconds
Time within 5 °C of actual peak temperature	30 seconds
Peak temperature range	260 +0/-5 °C
Ramp-down rate	6 °C/second max.
Time 25 °C to peak temperature	8 minutes max.
Maximum number of reflow cycles	≤ 3

## Revision History

Date	Description of Change	Revision
2022.05.05	First Draft.	1.0
2023.02.10	Operating frequency range change.	1.5